SPECIFICATION

PART NO. : OEL9M0093-W-E



This specification may be changed without any notice in order to improve performance or quality etc.

Please contact OLED R&D department TRULY Semiconductors LTD. For updated specification and product status before design for this product or release the order.

Rev :1.1

PRODUCT CONTENTS

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TRU	/LY ®信利	Customer	
Written by	ChenYongquan	App	roved by
Checked by	Yang Xueyu		
Approved by	Zhang Weicang		

REVISION HISTORY

Rev.	Contents	Date
1.0	First Release.	2014-06-04
1.1	Update the Schematic Example	2014-07-08

■ PHYSICAL DATA

No.	Items:	Specification:	Unit
1	Diagonal Size	0.48	Inch
2	Resolution	72(H) x 32(V)	Dots
3	Active Area	11.210 (W) x 4.970(H)	mm ²
4	Outline Dimension (Panel)	14.90 (W) x 11.29(H)	mm ²
5	Pixel Pitch	0.156 (W) x 0.156(H)	mm ²
6	Pixel Size	0.136(W) x 0.136(H)	mm ²
7	Driver IC	SSD1309Z	-
8	Display Color	White	-
9	Gray scale	1	Bit
10	Interface	4-SPI	-
11	IC package type	COG	-
12	Thickness	1.20±0.1	mm
13	Weight	TBD	g
14	Duty	1/32	-

■ ABSOLUTE MAXIMUM RATINGS

Unless otherwise specified, $V_{SS} = 0V$

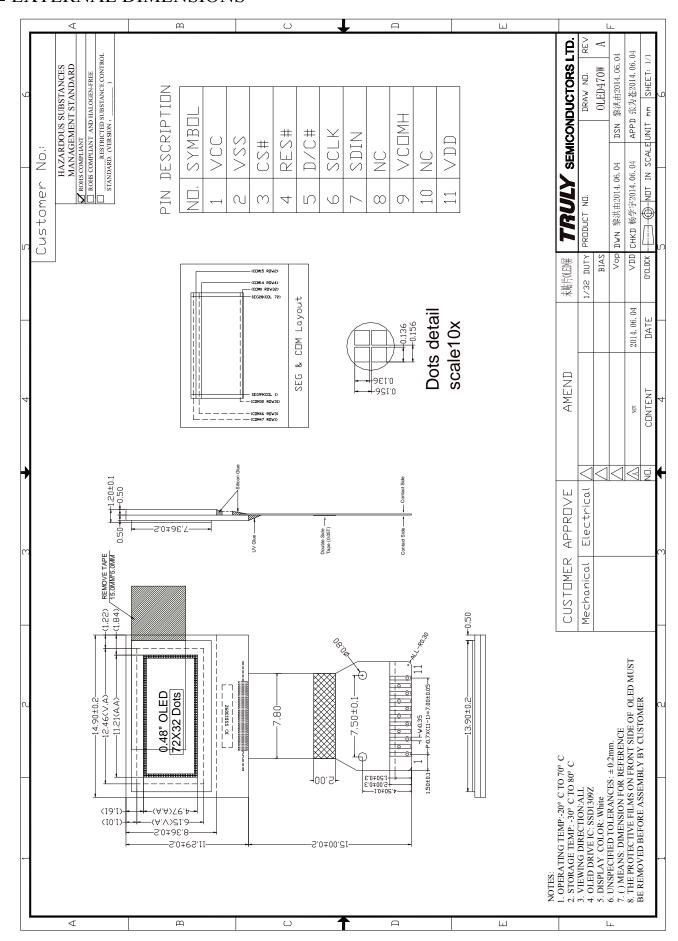
 $(Ta = 25^{\circ}C)$

I	tems	Symbol	Min	Тур.	Max	Unit
Supply	Logic	VDD	-0.3	-	4.0	V
Voltage	Driving	VCC	0	-	17.0	V
Operating '	Гетрегаture	Тор	-20	-	70	$^{\circ}$ C
Storage Te	mperature	Tst	-30	-	80	$^{\circ}$ C
Humidity		-	-	-	90	%RH

Note:

Permanent device damage may occur if ABSOLUTE MAXIMUM RATINGS are exceeded. Functional operation should be restricted to the conditions as detailed in the operational sections of this data sheet. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

■ EXTERNAL DIMENSIONS



■ ELECTRICAL CHARACTERISTICS

♦DC Characteristics

Unless otherwise specified, $V_{SS} = 0V$, VDD=1.65V to 3.3V.

 $(Ta = 25^{\circ}C)$

	Items	Symbol	Min	Typ.	Max	Unit
Supply	Logic	VDD	1.65	3	3.3	V
Voltage	Driving	VCC	7.0	10.0	16.0	V
Input	High Voltage	V_{IH}	0.8 x VDD	-	-	V
Voltage	Low Voltage	$V_{ m IL}$	-	-	0.2 x VDD	V
Output	High Voltage	V_{OH}	0.9x VDD	-	-	V
Voltage	Low Voltage	$ m V_{OL}$	-	-	0.1 x VDD	V

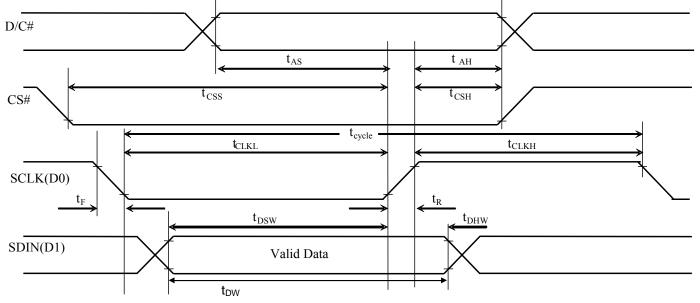
♦AC Characteristics

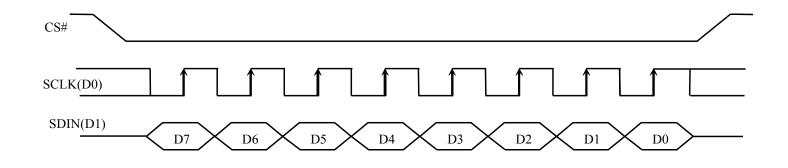
Serial Interface Timing Characteristics (4-wire SPI)

 $(VDD - VSS=1.65\sim3.3V,TA=+25^{\circ}C)$

Symbol	Parameter	Min	Тур	Max	Unit
$t_{ m cycle}$	Clock Cycle Time	100	-	-	ns
t_{AS}	Address Setup Time	15	-	-	ns
t_{AH}	Address Hold Time	15	-	-	ns
$t_{\rm CSS}$	Chip Select Setup Time	20	-	-	ns
t_{CSH}	Chip Select Hold Time	50	-	-	ns
$t_{ m DW}$	Data Write Time	55	-	-	ns
$t_{ m DSW}$	Write Data Setup Time	15	-	-	ns
$t_{ m DHW}$	Write Data Hold Time	15	-	-	ns
$t_{ m CLKL}$	Clock Low Time	50	-	-	ns
$t_{\rm CLKH}$	Clock High Time	50	-	-	ns
t_{R}	Rise Time	-	-	40	ns
t_{F}	Fall Time	-	-	40	ns

Serial interface characteristics (4-wire SPI)





■ ELECTRO-OPTICAL CHARACTERISTICS (Ta=25°C)

Items		Symbol	Min.	Тур.	Max.	Unit	Remark
Operating Lumi	nance	L	200	250*	-	cd/m2	White
Power Consum	ntion	P	-	15	20	mW	30% pixels ON
1 ower consum	риоп	1	_	13	20	111 VV	$L=250cd/m^2$
Frame Freque	ency	Fr	-	100	-	Hz	-
Color Coordinate	White	CIE x	0.255	0.285	0.315 CIE1931		Darkroom
Color Coordinate	VV IIIC	CIE y	0.300	0.330	0.360	CILITY	Darkfoom
Pagnanga Tima	Rise	Tr	-	-	0.02	ms	-
Response Time	Decay	Td	-	-	0.02	ms	-
Contrast Rat	io*	Cr	10000:1	-	-	-	Darkroom
Viewing An	gle	Δθ	160	_	-	Degree	-
Operating Life	Γime*	Тор	10000	-	-	Hours	L=250cd/m2

Note:

- **1.** L=250 cd/m² is based on $V_{DD}=3.0V$, $V_{cc}=10.0V$, contrast command setting 0X1A;
- **2. Contrast ratio** is defined as follows:

3. Life Time is defined when the Luminance has decayed to less than 50% of the initial Luminance specification. (Odd and even chess board alternately displayed). (The initial value should be closed to the typical value after adjusting.)





No	Symbol	Description
1	VCC	Power supply for panel driving voltage. This is also the most positive power voltage supply pin.
2	VSS	Ground pin. It must be connected to external ground.
3	CS#	This pin is the chip select input connecting to the MCU. The chip is enabled for MCU communication only when CS# is pulled LOW (active LOW).
4	RES#	This pin is reset signal input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin pull HIGH during normal operation.
5	D/C#	This pin is Data/Command control pin connecting to the MCU.
6	SCLK	The serial clock input PIN
7	SDIN	The serial data input PIN
8	NC	No connection.
9	VCOMH	COM signal deselected voltage level. Connected to VCC.
10	NC	No connection.
11	VDD	Power supply pin for core logic operation.



■ COMMAND TABLE

1. Fu	ndamen	tal C	omm	and '	Table	e					
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	81 A[7:0]	1 A7	0 A6	0 A5	0 A4	0 A3	0 A2	0 A1	1 A0	Set Contrast Control	Double byte command to select 1 out of 256 contrast steps. Contrast increases as the value increases. (RESET = 7Fh)
0	A4/A5	1	0	1	0	0	1	0	X0	Entire Display ON	A4h, X0=0b: Resume to RAM content display (RESET) Output follows RAM content. A5h, X0=1b: Entire display ON Output ignores RAM content.
0	A6/A7	1	0	1	0	0	1	1	X0	Set Normal/Inverse Display	A6h, X[0]=0b: Normal display (RESET). 0 in RAM: OFF in display panel 1 in RAM: ON in display panel
											A7h, X[0]=1b: Inverse display 0 in RAM: ON in display panel 1 in RAM: OFF in display panel
0	AE/AF	1	0	1	0	1	1	1	X0	Set Display ON/OFF	AEh, X[0]=0b:Display OFF (sleep mode) (RESET) AFh X[0]=1b:Display ON in normal mode
0	E3	1	1	1	0	0	0	1	1	NOP	Command for no operation.
0 0	FD A[2]	1 0	1 0	1 0	1 1	1 0	1 A2	0 1	1 0	Set Command Lock	A[2]: MCU protection status. A[2] = 0b, Unlock OLED driver IC MCU interface from entering command (RESET). A[2] = 1b, Lock OLED driver IC MCU interface from entering command. Note: The locked OLED driver IC MCU interface prohibits all command and memory access except the FDh command

O	2. Scr D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
Description B 2:0												
A[7:0] X			-			-		-				27h, X[0]=1, Left Horizontal Scroll
Digrate Figure Figure	-										Setup	A[7:0]: Dummy byte (Set as 00h)
B 2:0 Define start page address B 2:0 Define start page address												Horizontal scroll by 1 column
0 F[7:0] F7 F6 F5 F4 F3 F2 F1 F0 0 G[7:0] G7 G6 G5 G4 G3 G2 G1 G0			0	0	0	0	0					-
001b - PAGE1 100b - PAGE4 111b - PAGE7 010b - PAGE2 101b - PAGE5 C[2:0] : Set time interval between each scroll step in terms of fra frequency 000b - 5 frames 100b - 2 frames 001b - 64 frames 101b - 3 frames 010b - 128 frames 110b - 4 frames 011b - 256 frames 111b - 1 frames D[2:0] : Define end page address 000b - PAGE0 011b - PAGE3 110b - PAGE6 001b - PAGE1 100b - PAGE4 111b - PAGE7 010b - PAGE2 101b - PAGE5 E[7:0] : Dummy byte (Set as 00h) F[7:0] : Define the start column (RESET = 00h) G[7:0] : Define the start column (RESET = 7Fh) Notes: (1) The value of D[2:0] must be larger than or equal to B[2:0]										_		
Dilb - PAGE2 101b - PAGE5	0	G[7:0]	G7	G6	G5	G4	G3	G2	G1	G0		000b – PAGE0
C[2:0]: Set time interval between each scroll step in terms of fra frequency 000b - 5 frames												001b – PAGE1 100b – PAGE4 111b – PAGE7
frequency 000b - 5 frames												010b – PAGE2 101b – PAGE5
000b - 5 frames 100b - 2 frames												
001b - 64 frames												frequency
010b - 128 frames 110b - 4 frames 011b - 256 frames 111b - 1 frames 000b - PAGE0 011b - PAGE3 110b - PAGE6 001b - PAGE1 100b - PAGE4 111b - PAGE7 010b - PAGE2 101b - PAGE5 E[7:0] : Dummy byte (Set as 00h) F[7:0] : Define the start column (RESET = 00h) G[7:0] : Define the end column address (RESET = 7Fh) Notes: (1) The value of D[2:0] must be larger than or equal to B[2:0]												000b – 5 frames 100b – 2 frames
D[2:0] : Define end page address												001b – 64 frames 101b – 3 frames
D[2:0] : Define end page address 000b - PAGE0												010b – 128 frames 110b – 4 frames
D[2:0] : Define end page address 000b - PAGE0												011b – 256 frames 111b – 1 frames
001b - PAGE1 100b - PAGE4 111b - PAGE7 010b - PAGE2 101b - PAGE5 E[7:0]: Dummy byte (Set as 00h) F[7:0]: Define the start column (RESET = 00h) G[7:0]: Define the end column address (RESET = 7Fh) Notes: (1) The value of D[2:0] must be larger than or equal to B[2:0]												D[2:0] : Define end page address
001b – PAGE1 100b – PAGE4 111b – PAGE7 010b – PAGE2 101b – PAGE5 E[7:0] : Dummy byte (Set as 00h) F[7:0] : Define the start column (RESET = 00h) G[7:0] : Define the end column address (RESET = 7Fh) Notes: (1) The value of D[2:0] must be larger than or equal to B[2:0]												000b – PAGE0 011b – PAGE3 110b – PAGE6
D10b – PAGE2 101b – PAGE5 E[7:0]: Dummy byte (Set as 00h) F[7:0]: Define the start column (RESET = 00h) G[7:0]: Define the end column address (RESET = 7Fh) Notes: (1) The value of D[2:0] must be larger than or equal to B[2:0]												
E[7:0]: Dummy byte (Set as 00h) F[7:0]: Define the start column (RESET = 00h) G[7:0]: Define the end column address (RESET = 7Fh) Notes: (1) The value of D[2:0] must be larger than or equal to B[2:0]												
G[7:0]: Define the end column address (RESET = 7Fh) Notes: (1) The value of D[2:0] must be larger than or equal to B[2:0]												E[7:0] : Dummy byte (Set as 00h)
(1) The value of D[2:0] must be larger than or equal to B[2:0]												
(1) The value of D[2:0] must be larger than or equal to B[2:0]												Notes:

2. Scr	olling C	omn	nand	Tabl	e						
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D 0	Command	Description
0	29/2A A[0]	0	0	1	0	1	0	X1 *	X0 A0	Continuous Vertical and	29h, X1X0=01b: Vertical and Right Horizontal Scroll 2Ah, X1X0=10b: Vertical and Left Horizontal Scroll
0 0 0 0	B[2:0] C[2:0] D[2:0] E[5:0] F[7:0]	* * * F7	* * * F6	* * * E5 F5	* * * E4 F4	* * E3 F3	B2 C2 D2 E2 F2	B1 C1 D1 E1 F1	B0 C0 D0 E0 F0	Horizontal Scroll Setup	A[0]: Set number of column scroll offset 0b No horizontal scroll 1b Horizontal scroll by 1 column B[2:0]: Define start page address
0	G[7:0]	G7	G6	G5	G4	G3	G2	G1	G0		000b – PAGE0
											001b – PAGE1 100b – PAGE4 111b – PAGE7
											010b – PAGE2 101b – PAGE5
											C[2:0] : Set time interval between each scroll step in terms of frame frequency
											000b – 5 frames 100b – 2 frames
											001b – 64 frames 101b – 3 frames
											010b – 128 frames 110b – 4 frames
											011b – 256 frames 111b – 1 frames
											D[2:0] : Define end page address
											000b – PAGE0 011b – PAGE3 110b – PAGE6
											001b - PAGE1
											010b – PAGE2 101b – PAGE5
											E[5:0]: Vertical scrolling offset e.g. E[5:0] = 01h refer to offset = 1 row E[5:0] = 3Fh refer to offset = 63 rows F[7:0]: Define the start column (RESET = 00h) G[7:0]: Define the end column address (RESET = 7Fh) Note: (1) The value of D[2:0] must be larger than or equal to B[2:0] (2) The value of G[7:0] must be larger than or equal to F[7:0]
0	2E	0	0	1	0	1	1	1	0	Deactivate scroll	Stop scrolling that is configured by command 26h/27h/29h/2Ah. Note: After sending 2Eh command to deactivate the scrolling action, the ram data needs to be rewritte

• 0	*** **			- · ·							
	olling C					D2	D2	D1	DO	C1	D
D/C#	Hex 2F	D7	D6	D5	D4	D3	D2	D1	D0	Activate scroll	Description Start scrolling that is configured by the scrolling setup commands :26h/27h/29h/2Ah with the following valid sequences:
											Valid command sequence 1: 26h; 2Fh. Valid command sequence 2: 27h; 2Fh. Valid command sequence 3: 29h; 2Fh. Valid command sequence 4: 2Ah; 2Fh.
											For example, if "26h; 2Ah; 2Fh." commands are issued, the setting in the last scrolling setup command, i.e. 2Ah in this case, will be executed. In other words, setting in the last scrolling setup command overwrites the setting in the previous scrolling setup commands.
0 0 0	A3 A[5:0] B[6:0]	1 * *	0 * B6	1 A5 B5	0 A4 B4	0 A3 B3	0 A2 B2	1 A1 B1	1 A0 B0	Set Vertical Scroll Area	A[5:0]: Set No. of rows in top fixed area. The No. of rows in top fixed area is referenced to the top of the GDDRAM (i.e. row 0).[RESET = 0] B[6:0]: Set No. of rows in scroll area. This is the number of rows to be used for vertical scrolling. The scroll area starts in the first row below the top fixed area. [RESET = 64]
											Note: (1) A[5:0]+B[6:0] <= MUX ratio (2) B[6:0] <= MUX ratio (3a) Vertical scrolling offset (E[5:0] in 29h/2Ah) < B[6:0] (3b) Set Display Start Line (X5X4X3X2X1X0 of 40h~7Fh)
0 0 0 0 0 0	2C/2D A[7:0] B[2:0] C[7:0] D[2:0] E[7:0] F[7:0] G[7:0]	0 0 * 0 * 0 F7 G7	0 0 * 0 * 0 F6 G6	1 0 * 0 F5 G5	0 0 * 0 * 0 F4 G4	1 0 * 0 * 0 F3 G3	1 0 B2 0 D2 0 F2 G2	0 0 B1 0 D1 0 F1 G1	X0 0 B0 1 D0 0 F0 G0	Content Scroll Setup	2Ch, X[0]=0, Right Horizontal Scroll by one column 2Dh, X[0]=1, Left Horizontal Scroll by one column A[7:0]: Dummy byte (Set as 00h) Horizontal scroll by 1 column B[2:0]: Define start page address 000b - PAGE0

	dressing										
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	00~0F	0	0	0	0	X3	X2	X1	X0	Set Lower Column Start Address for Page Addressing Mode	Set the lower nibble of the column start address register for Page Addressing Mode using X[3:0] as data bits. The initial display line register is reset to 0000b after RESET. Note: This command is only for page addressing mode
0	10~1F	0	0	0	1	X3	X2	X1	X0	Set Higher Column Start Address for Page Addressing Mode	Set the higher nibble of the column start address register for Page Addressing Mode using X[3:0] as data bits. The initial display line register is reset to 0000b after RESET. Note: This command is only for page addressing mode
0	20 A[1:0]	0 *	0 *	1 *	0 *	0 *	0 *	0 A1	0 A0	Set Memory Addressing Mode	A[1:0] = 00b, Horizontal Addressing Mode A[1:0] = 01b, Vertical Addressing Mode A[1:0] = 10b, Page Addressing Mode (RESET) A[1:0] = 11b, Invalid
0 0 0	21 A[7:0] B[7:0]	0 A7 B7	0 A6 B6	1 A5 B5	0 A4 B4	0 A3 B3	0 A2 B2	0 A1 B1	1 A0 B0	Set Column Address	Setup column start and end address A[7:0]: Column start address, range: 0-127d, (RESET=0d) B[7:0]: Column end address, range: 0-127d, (RESET =127d)
											Note: This command is only for horizontal or vertical addressing mode.
0 0 0	22 A[2:0] B[2:0]	0 * *	0 * *	1 * *	0 * *	0 * *	0 A2 B2	1 A1 B1	0 A0 B0	Set Page Address	Setup page start and end address A[2:0]: Page start Address, range: 0-7d, (RESET = 0d) B[2:0]: Page end Address, range: 0-7d, (RESET = 7d) Note:
											This command is only for horizontal or vertical addressing mode.
0	B0~B7	1	0	1	1	0	X2	X1	X0	Set Page Start Address for Page Addressing Mode	Set GDDRAM Page Start Address (PAGE0~PAGE7) for Page Addressing Mode using X[2:0]. Note: This command is only for page addressing mode



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D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D 0	Command	Description
0	40~7F	0	1	X5	X4	Х3	X2	X1	X0	Set Display Start Line	Set display RAM display start line register from 0-63 using X5X3X2X1X0. Display start line register is reset to 000000b during RESET.
0	A0/A1	1	0	1	0	0	0	0	X0	Set Segment Remap	A0h, X[0]=0b: column address 0 is mapped to SEG0 (RESET) A1h, X[0]=1b: column address 127 is mapped to SEG0
0 0	A8 A[5:0]	1 *	0 *	1 A5	0 A4	1 A3	0 A2	0 A1	0 A0	Set Multiplex Ratio	Set MUX ratio to N+1 MUX N=A[5:0]: from 16MUX to 64MUX, RESET= 111111b (i.e. 63d, 64MUX) A[5:0] from 0 to 14 are invalid entry.
0	C0/C8	1	1	0	0	X3	0	0	0	Set COM Output Scan Direction	C0h, X[3]=0b: normal mode (RESET) Scan from COM0 to COM[N -1] C8h, X[3]=1b: remapped mode. Scan from COM[N-1] to COM0 Where N is the Multiplex ratio.
0	D3 A[5:0]	1	1 *	0 A5	1 A4	0 A3	0 A2	1 A1	1 A0	Set Display Offset	Set vertical shift by COM from 0d~63d The value is reset to 00h after RESET.
0	DA A[5:4]	1 0	1 0	0 A5	1 A4	1 0	0	1 1	0	Set COM Pins Hardware Configuration	A[4]=0b, Sequential COM pin configuration A[4]=1b (RESET), Alternative COM pin configuration A[5]=0b (RESET), Disable COM Left/Right remap A[5]=1b, Enable COM Left/Right remap
0	DC A[1:0]	1 0	1 0	0	1 0	1 0	1 0	0 A1	0 A0	Set GPIO	A[1:0] GPIO: 00 pin HiZ, Input disabled 01 pin HiZ, Input enabled 10 pin output LOW [RESET] 11 pin output HIGH

D/C#	Hex	D7	D6	D 5	D4	D3	D2	D1	D 0	Command	Description	
0	D5	1	1	0	1	0	1	0	1	Set Display Clock	A[3:0]: Define the divide ratio (D) of the display clocks (DCLK	
0	A[7:0]	A7	A6	A5	A4	A3	A2	A1	A0	Divide	Divide ratio= $A[3:0] + 1$, RESET is 0000b	
										Ratio/Oscillator	(divide ratio = 1)	
										Frequency	A[7:4] : Set the Oscillator Frequency, FOSC.	
											Oscillator Frequency increases with the	
											value of A[7:4] and vice versa. RESET is 0111b	
											Range:0000b~1111b	
									Frequency increases as setting value increases		Frequency increases as setting value increases.	
0	D9	1	1	0	1	1	0	0	1	Set Pre-charge	A[3:0]: Phase 1 period of up to 15 DCLK	
0	A[7:0]	A7	A6	A5	A4	A3	A2	A1	A0	Period	Clock 0 is invalid entry	
											(RESET=2h)	
											A[7:4]: Phase 2 period of up to 15 DCLK	
											Clock 0 is invalid entry	
											(RESET=2h)	
0	DB	1	1	0	1	1	0	1	1	Set VCOMH		
0	A[5:2]	0	0	A5	A4	A3	A2	0	0	Deselect Level	A[5:2] Hex code VCOMH deselect level	

A[5:2]	Hex code	VCOMH deselect level
0000b	00h	~ 0.64 x VCC
1101b	34h	~ 0.78 x VCC (RESET)
1111b	3Ch	~ 0.84 x VCC

Note: "*" stands for "Don't care".

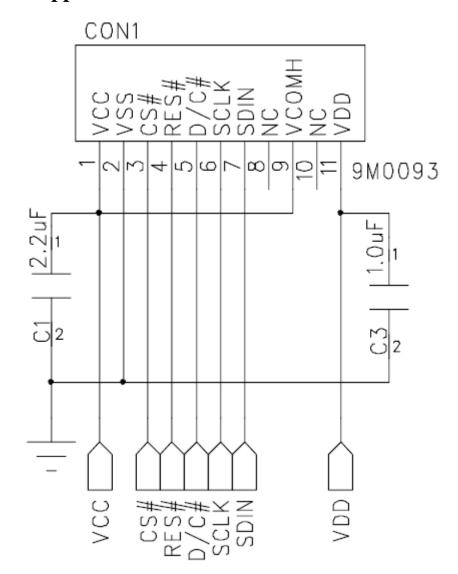
■ INITIALIZATION CODE

```
void InitOLED MASTER SSD1309(void)
  MainOLED WCom(0xFD);
                                  //Set Command Lock
  MainOLED WCom(0x12);
  MainOLED WCom(0xAE);
                                  //Display OFF(sleep mode)(RESET)
  MainOLED WCom(0x81);
                                  //Contarst Control(00H-FFH)
  MainOLED WCom(CONTRAST);
  MainOLED WCom(0xA4);
                                  //Entire Display ON
 MainOLED WCom(0xA6);
                                  //Set Normal Display
                                  //Set DC-DC (charge Pump)
  MainOLED_WCom(0x8D);
  MainOLED WCom(0x14);
                                  //Enable charge Pump
  MainOLED WCom(0xD8);
                                  //Set low power display mode
                                  //Lower power display mode
  MainOLED WCom(0x05);
  MainOLED WCom(0XAD);
  MainOLED WCom(0X48);
  MainOLED WCom(0x40);
                                  //Set Display Strart Line (040H-07FH)
  MainOLED_WCom(0xA1);
                                  //Set Segment Re-Map
  MainOLED WCom(0xA8);
                                  //Set Multiplex Ratio 64
  MainOLED_WCom(0x1F);
  MainOLED WCom(0xC8);
                                  //Com Scan Com1-Com64
  MainOLED_WCom(0xD3);
                                  //Set Display Offset(00H-3FH)
  MainOLED WCom(0x00);
  MainOLED WCom(0xDA);
                                  //Com Pin Configuration
  MainOLED WCom(0x12);
  MainOLED WCom(0xD5);
                                  //Set Frame Frequency
  MainOLED WCom(0x80);
  MainOLED WCom(0xD9);
                                  //Set Pre-Charge Period
  MainOLED WCom(0xF1);
  MainOLED WCom(0xDB);
                                  //Set VCOM Deselect Level
 MainOLED WCom(0x20);
 MainOLED WCom(0xAF);
                                  //Dsplay ON
```

}

■ SCHEMATIC EXAMPLE

♦Serial Interface Application Circuit:





■ RELIABILITY TESTS

	Item	Condition	Criterion		
High Te	emperature Storage (HTS)	80±2°€, 200 hours	 After testing, the function test is ok. After testing, no addition to the defect. 		
High Ter	nperature Operating (HTO)	70±2°C, 96 hours	3. After testing, the change of luminance should be within +/- 50% of initial value.		
Low Te	emperature Storage (LTS)	-30±2°C, 200 hours	4. After testing, the change for the mono and area color must be within (+/-0.02, +/-		
Low Ten	nperature Operating (LTO)	-20±2°€, 96 hours	0.02) and for the full color it must be within (+/-0.04, +/-0.04) of initial value based on		
High Tempe	erature / High Humidity Storage (HTHHS)	50±3°C, 90%±3%RH, 120 hours	1931 CIE coordinates. 5. After testing, the change of total current consumption should be		
Thermal S	hock (Non-operation) (TS)	-20±2°C ~ 25°C ~ 70±2°C (30min) (5min) (30min) 10cycles	within +/- 50% of initial value.		
Vibration (Packing)	10~55~10Hz,amplitu de 1.5mm, 1 hour for each direction x, y, z	1. One box for each test.			
Drop (Packing)	Height: 1 m, each time for 6 sides, 3 edges, 1 angle	2. No addition to the cosmetic	and the electrical defects.		
ESD (finished product housing) ±4kV (R: 330Ω C: 150pF, 10times, air discharge)		 After testing, cosmetic and electrical defects should not happen. In case of malfunction or defect caused by ESD damage, it would be judged as a good part if it would be recovered to normal state after resetting. 			

Note: 1) For each reliability test, the sample quantity is 3, and only for one test item.

- 2) The HTHHS test is requested the Pure Water(Resistance>10 $M\Omega$).
- 3) The test should be done after 2 hours of recovery time in normal environment.

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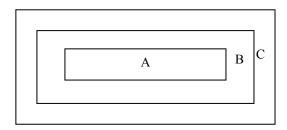
■ OUTGOING QUALITY CONTROL SPECIFICATION

♦Standard

According to GB/T2828.1-2003/ISO 2859-1: 1999 and ANSI/ASQC Z1.4-1993, General Inspection Level II.

◆ Definition

- 1 Major defect: The defect that greatly affect the usability of product.
- 2 Minor defect: The other defects, such as cosmetic defects, etc.
- 3 Definition of inspection zone:



Zone A: Active Area

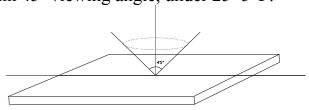
Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer's product.

◆Inspection Methods

1 The general inspection: under 20W x 2 or 40W fluorescent light, about 30cm viewing distance, within 45° viewing angle, under 25±5°C.



2 The luminance and color coordinate inspection: By PR705 or BM-7 or the equal equipments, in the dark room, under 25±5°C.

♦Inspection Criteria

1 Major defect: AOL= 0.65

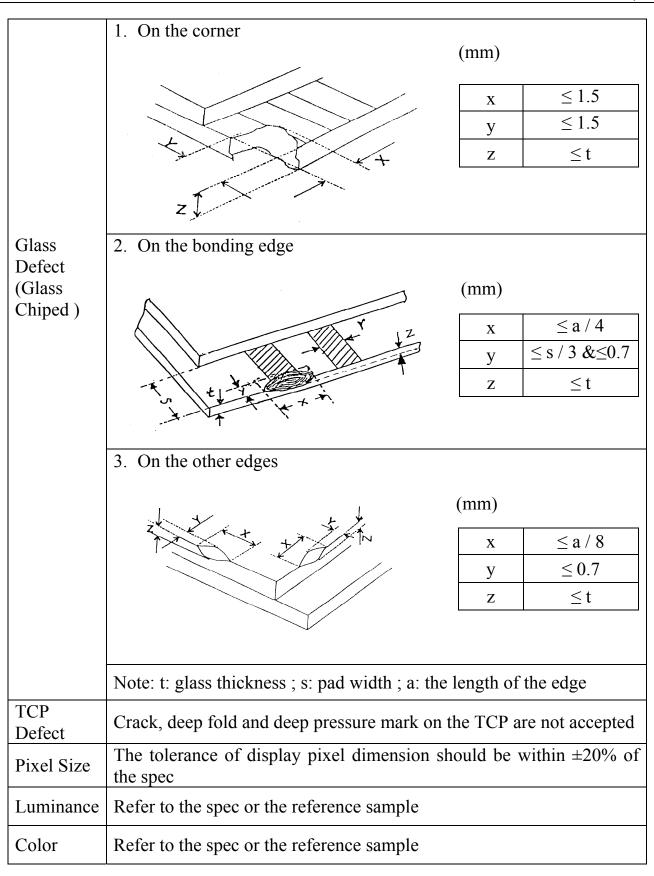
Item	Criterion					
F (1. No display or abnormal display is not accepted					
Function Defect	2. Open or short is not accepted.					
	3. Power consumption exceeding the spec is not accepted.					
Outline Dimension	Outline dimension exceeding the spec is not accepted.					
Glass Crack	Glass crack tends to enlarge is not accepted.					



2 Minor Defect : AQL= 1.5

Minor Defect	. AQL- 1.3	~							
Item	Criterion								
Const	Size	(mm)	Accepted Qty						
Spot Defect			Area A + Area B	Area C					
(dimming		Φ≦0.07	Ignored						
and	Y	$0.07 < \Phi \leq 0.10$	3						
lighting	X	$0.10 < \Phi \le 0.15$	1	Ignored					
spot)		0.15<Φ	0						
	Note: $\Phi = (x + y) / 2$								
Line	L (Length): mm	W (Width): mm	Area A + Area B	Area C					
Defect	/	W ≤ 0.02	Ignored						
(dimming and	L≦3.0	$0.02 < W \le 0.03$	2	Ignored					
lighting	L≦2.0	$0.03 < W \le 0.05$	1						
line)	/	0.05 <w< td=""><td>As spot defect</td><td colspan="3"></td></w<>	As spot defect						
	1 & 5								
Stalli	Line Defect.	, otherwise, according	g to the Spot Defect	and the					
	1. If scratch can be seen during operation, according to the criterions of the Spot Defect and the Line Defect.								
	2. If scratch can be seen only under non-operation or some special angle, the criterion is as below:								
Polarizer	L (Length): mm	W (Width): mm	Area A + Area B	Area C					
Scratch	/	W ≤ 0.02	Ignore						
	3.0 <l≦5.0< td=""><td>$0.02 < W \le 0.04$</td><td>2</td><td></td></l≦5.0<>	$0.02 < W \le 0.04$	2						
	L≦3.0	$0.04 < W \le 0.06$	1	Ignore					
	/	0.06 <w< td=""><td>0</td><td></td></w<>	0						
	Si	ze	Area A + Area B	Area C					
Polarizer		Φ≦0.20	Ignored						
Air Bubble	(%%%%%) Y	$0.20 < \Phi \leq 0.30$	2						
	X	$0.30 < \Phi \le 0.50$	1	Ignored					
		0.50<Φ	0						





■ CAUTIONS IN USING OLED MODULE

◆Precautions For Handling OLED Module:

- 1. OLED module consists of glass and polarizer. Pay attention to the following items when handling:
 - i. Avoid drop from high, avoid excessive impact and pressure.
 - ii. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead.
 - iii. If the surface becomes dirty, breathe on the surface and gently wipe it off with a soft dry cloth. If it is terrible dirty, moisten the soft cloth with Isopropyl alcohol or Ethyl alcohol. Other solvents may damage the polarizer. Especially water, Ketone and Aromatic solvents.
 - iv. Wipe off saliva or water drops immediately, contact the polarizer with water over a long period of time may cause deformation.
 - v. Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peeling-off may occur with high temperature and high humidity.
 - vi. Condensation on the surface and the terminals due to cold or anything will damage, stain or dirty the polarizer, so make it clean as the way of iii.
- 2. Do not attempt to disassemble or process the OLED Module.
- 3. Make sure the TCP or the FPC of the Module is free of twisting, warping and distortion, do not pull or bend them forcefully, especially the soldering pins. On the other side, the SLIT part of the TCP is made to bend in the necessary case.
- 4. When assembling the module into other equipment, give the glass enough space to avoid excessive pressure on the glass, especially the glass cover which is much more fragile.
- 5. Be sure to keep the air pressure under 120 kPa, otherwise the glass cover is to be cracked.
- 6. Be careful to prevent damage by static electricity:
 - i. Be sure to ground the body when handling the OLED Modules.
 - ii. All machines and tools required for assembling, such as soldering irons, must be properly grounded.
 - iii. Do not assemble and do no other work under dry conditions to reduce the amount of static electricity generated. A relative humidity of 50%-60% is recommended.
 - iv. Peel off the protective film slowly to avoid the amount of static electricity generated.
 - v. Avoid to touch the circuit, the soldering pins and the IC on the Module by the body.
 - vi. Be sure to use anti-static package.
- 7. Contamination on terminals can cause an electrochemical reaction and corrade the terminal circuit, so make it clean anytime.
- 8. All terminals should be open, do not attach any conductor or semiconductor on the terminals.
- 9. When the logic circuit power is off, do not apply the input signals.
- 10. Power on sequence: $V_{DD} \rightarrow V_{CC}$, and power off sequence: $V_{CC} \rightarrow V_{DD}$.
- 11. Be sure to keep temperature, humidity and voltage within the ranges of the spec, otherwise shorten Module's life time, even make it damaged.
- 12. Be sure to drive the OLED Module following the Specification and datasheet of IC controller, otherwise something wrong may be seen.

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13. When displaying images, keep them rolling, and avoid one fixed image displaying more than 30 seconds, otherwise the residue image is to be seen. This is the speciality of OLED.

◆Precautions For Soldering OLED Module:

1. Soldering temperature : $260^{\circ}\text{C} \pm 10^{\circ}\text{C}$.

2. Soldering time: 3-4 sec.

3. Repeating time: no more than 3 times.

4. If soldering flux is used, be sure to remove any remaining flux after finishing soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended to protect the surface with a cover during soldering to prevent any damage due to flux spatters.

◆ Precautions For Storing OLED Module:

- 1. Be sure to store the OLED Module in the vacuum bag with dessicant.
- 2. If the Module can not be used up in 1 month after the bag being opened, make sure to seal the Module in the vacuum bag with dessicant again.
- 3. Store the Module in a dark place, do not expose to sunlight or fluorescent light.
- 4. The polarizer surface should not touch any other objects. It is recommended to store the Module in the shipping container.
- 5. It is recommended to keep the temperature between 0°C and 30°C, the relative humidity not over 60%.

♦ Limited Warranty

Unless relevant quality agreements signed with customer and law enforcement, for a period of 12 months from date of production, all products (except automotive products) TRULY will replace or repair any of its OLED modules which are found to be functional defect when inspected in accordance with TRULY OLED acceptance standards (copies available upon request). Cosmetic/visual defects must be returned to TRULY within 90 days of shipment. Confirmation of such date should be based on freight documents. The warranty liability of TRULY is limited to repair and/or replacement on the terms above. TRULY will not be responsible for any subsequent or consequential events.

◆Return OLED Module Under Warranty:

- 1. No warranty in the case that the precautions are disregarded.
- 2. Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects.

♦PRIOR CONSULT MATTER

- 1. For TRULY standard products, we keep the right to change material ,process ... for improving the product property without any notice on our customer.
- 2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.